



Winbond Electronics Corporation

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Product Obsolescence Notice

W25Q16JV SpiFlash Memories

Notification Date: Aug, 11, 2016

Dear Valued Customer,

This letter is to notify you of Winbond’s intention to terminate production of the W25Q16DV SpiFlash memory, and replace it with the W25Q16JV. Replacement part numbers are listed below:

Winbond Current PN (90nm D-Series)	Winbond Primary Replacement PN (58nm J-Series)
W25Q16DVSNIQ	W25Q16JVSNIQ
W25Q16DVSSIG	W25Q16JVSSIQ
W25Q16DVSSIQ	
W25Q16DVZPIG	W25Q16JVZPIQ
W25Q16DVZPIQ	
W25Q16DVUUIG	W25Q16JVUUIQ
W25Q16DVUZIG	W25Q16JVXGIQ

The W25Q16JV device features:

Features

- a) Command backward compatible with W25Q16DV (same Superset Instruction Set)
- b) Clock operation up to 133MHz
- c) Lower power consumption
- d) SPI with Single / Dual / Quad
- e) Flexible architecture with 4KB sectors

Please refer to the table below for your particular product last time order date and Winbond last shipment date and use this table to determine your last time buys and subsequent request dates. Winbond Electronics reserves the right to limit last time buy quantities based on capacity and material availability. Please notify Winbond as soon as possible if there are any concerns with these this schedule.

Part Number	Notification Date	Last Order Date	Last Ship Date	Part Number	Reliability Report	Mass Production
W25Q16DV	Jul./21/ 2016	Jan./21/ 2017	Jul./21/ 2017	W25Q16JV	Aug./15/ 2016	May/12/ 2016

Eddy Hung

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